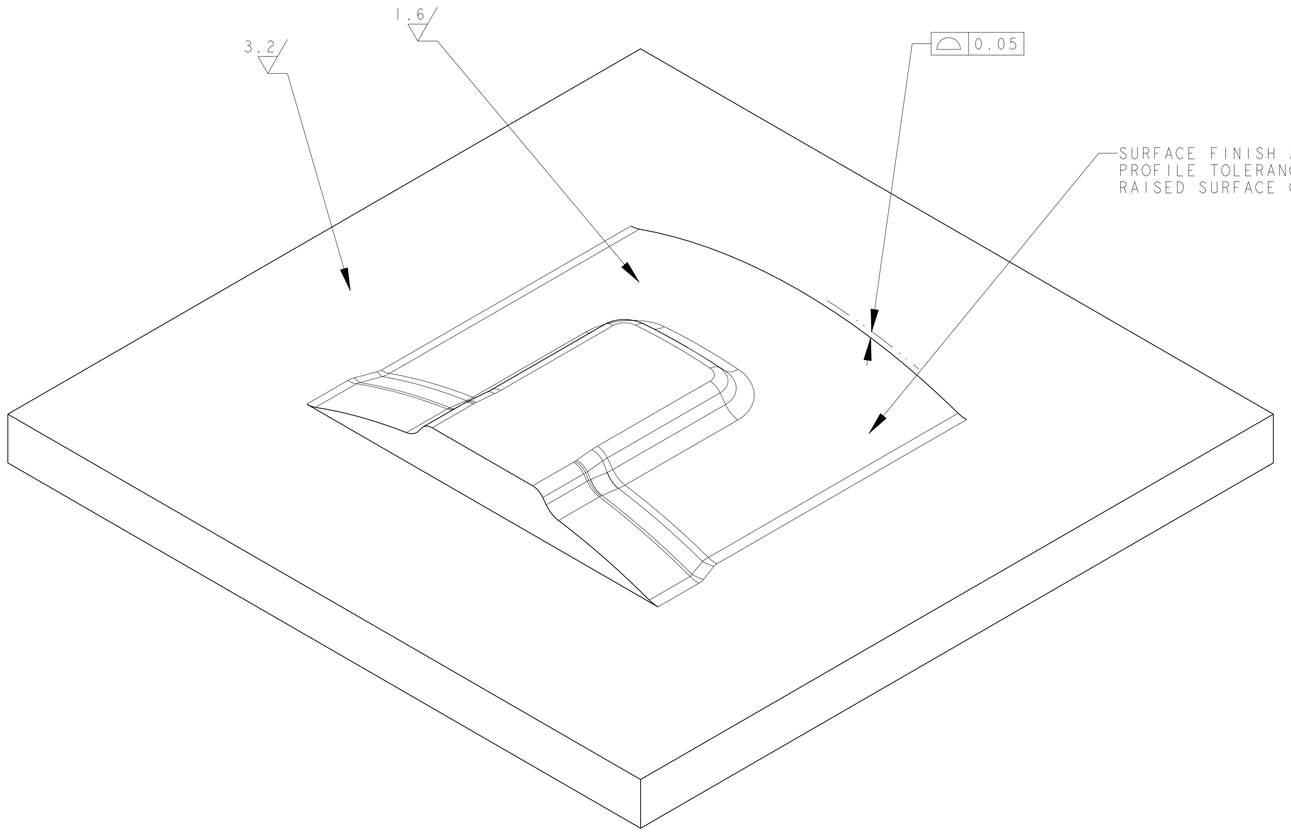
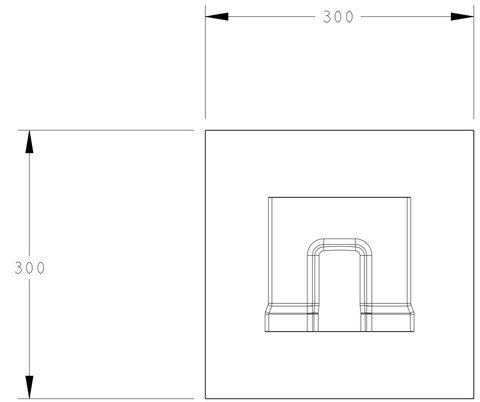
DWG. NO.	SIZE	REV.	SH.
2501064	1	1	

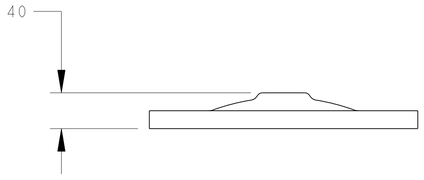
DESCRIPTION	MATERIAL	MAT. LOCATION
-	PRODEC 316SS	-



MACHINE USING IGES FILE 'MOUNT_PAD_TOOL.IGS'



SCALE 3/10



REF STOCK DIMENSIONS:
MINIMUM BASE SIZE, ADD MATERIAL
AS REQUIRED FOR FIXTURING

REV	DWG	CHK	ZONE	DATE	CHANGES

UNLESS OTHERWISE SPECIFIED

TOLERANCES:
- X.X ± 0.5
- FRAC. ± 1/64
- X.XX ± 0.05
- Angles ± 1.00°
- X.XXX ± 0.010
- FINISH 125 µinch

DO NOT SCALE PRINT

THREADS ARE CLASS 2

CHAMFER ENDS OF ALL SCREW TREADS 30°

CUT ROUND, 1.5 THREAD RELIEF ON MACHINED THREADS

BREAK EDGES .016 MAX. ON MACHINED WORK

REMOVE BURRS, WELD SPLATTER & LOOSE SCALE

IN ACCORDANCE WITH ASME Y14.5M & B46.1

SHOP ORDERS

ACCT NO.	NO. REQD	SER NO.	-
DEL TO		DATE ISSD	-
SURFACE TREATMT	-	DATE REQD	-
IDENT METHOD	TAG		
PROJECT NUMBER	N/A		
PROJECT NAME	US ATLAS SILICON SUBSYSTEM		
DWG BY	ANDERSSEN	DATE	15-Feb-03
CHK BY	HARTMAN	DATE	
APR BY	GILCHRIESE	DATE	

US ATLAS SILICON SUBSYSTEM (1 sign)

ERNEST ORLANDO LAWRENCE
BERKELEY NATIONAL LABORATORY
UNIVERSITY OF CALIFORNIA - BERKELEY

ATLAS PIXEL DETECTOR
PIXEL SUPPORT TUBE
BARREL MOUNT PAD TOOL

MICROFILMED:	DWG. TYPE	SHOWN ON	SCALE: 1/1	DO NOT SCALE PRINTS
	PART	210XXX	SHEET 1 OF 1	
PATENT CLEAR:	DESIGN ACCT. NO.	CATEGORY CODE	DWG. NO.	SIZE / REV.
	PIAP11	AP6300	2501064	1

Dwg File: 2501064_Model File: MOUNT_PAD_TOOL_BASE

BY: JJADER 10/4/2